

12th Global Conference on **Materials Science and Engineering (CMSE 2023)**

Shenzhen, China | October 27-30, 2023 www.cmseconf.org











About CMSE 2023

Organized by Macao Convention and Exhibition Association and Co-organized by Peking University Shenzhen Institute, the 12th Global Conference on Materials Science and Engineering (CMSE 2023) will be held on October 27-30, 2023 in Shenzhen, China.

Based on the previous 11 events, CMSE 2023 will continue to dedicate to covering all theoretical and experimental aspects of materials science and engineering aiming at providing an international academic platform for researchers and scholars to present their latest findings, and to facilitate networking and in-depth discussion with peers from different countries.

Welcome to CMSE 2023 in Shenzhen!

Conference Program

Registration October 27

October 28 Welcoming Speech, Keynote Speeches.

Poster & Oral Presentations

Oral Presentations, Welcome Banquet October 29

October 30 Field Visit

Presentation Types & Time Allocation

Keynote Presentation Invited Presentation **Regular Oral Presentation** Poster Presentation

40 min 25 min 15 min 1-2 hours

Important Dates

Submisison Deadline August 24, 2023 Registration Deadline September 7, 2023 Conference date October 27-30, 2023 **Group Tour** October 30, 2023

Registration Information

Registration Type Registration Fee

Standard Registration USD 500 / 3500 CNY

Student / Listener USD 400 / 2800 CNY

Registration Entitlement:

- 1. Oral/Poster Presentation, Conference materials
- 2. Access to all technical sessions and coffee breaks
- 3. Lunches and dinners on October 28-29, 2023
- 4. Field visit on October 30 in Shenzhen
- 5. Publishing one full paper in the conference proceedings

Call for Paper



The topics of interest include but are not limited to:

- · Composite, Coating and Ceramic Materials
- · Metals, Mining, Metallurgy and Materials
- · Structural Materials
- · Surface Science and Engineering
- · Characterization & Testing
- · Nanomaterials and Nanotechnology
- · Electronic, Optical and Magnetic Materials
- · Material Mechanics

Paper Submission

Abstracts/Full Papers should be CMSE2023 submitted the Submission System via the official website at www.cmseconf.org

- Abstracts submitted for attendance will not be published in any journals.
- All submitted full papers will go through peer-review process.

Paper Publication

Conference proceedings

Journal of Physics: Conference Series (EI/Scopus)

SCI Journals

- · Strength of Materials
- Materials Science-Medziagotyra
- · Ceramic-Silikaty
- Mechanika
- Archives of Metallurgy and Materials
- Science and Engineering of Composite Materials

Conference Committee

Dr. Alexander Khotsianovsky. Pisarenko Institute of Problems of Strength of the National Academy of Sciences of Ukraine. Ukraine

Dr. Enrico Zacchei, Itecons - Institute for Research and Technological Development in Construction, Energy, Environment and Sustainability, Portugal

Dr. Erik Vargas Rojas, Metropolitan Technological University, Mexico

Dr. Henryk Paul, Institute of Metallurgy and Materials Science, Poland

Dr. Osman Adiguzel, Firat University, Turkey

Dr. Pavol Hvizdos, Institute of Materials Research of SAS, Slovakia

Dr. Qixin Guo, Saga University, Japan

Dr. Sigitas Tamulevičius, Kaunas University of Technology (KTU), Republic of Lithuania

Dr. Payam Shafigh, University of Malaya, Malaysia

Check complete list at http://www.cmseconf.org/TPC

WELCOME TO SHENZHEN!













CONTACT US

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Dayhello International Hotel Shenzhen (Baoan) 深圳登喜路国际大洒店

Address: 12 Baotian Road 1. Bao'an District. Shenzhen (广东省深圳市宝安区宝田一路12号)

Tel.: +86-755-23008888

Website: http://www.davhellohotel.com



Conference Venue



Shenzhen is located in the southern portion of the Guanadona Province. on the eastern shore of the Pearl River Delta. Neighboring the Pearl River Delta and Hong Kong, Shenzhen's location gives it a geographical advantage for economic development.

CMSE Conference History



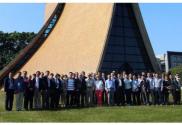




CMSE 2014 in Shanghai



CMSE 2015 in Macau



CMSE 2016 in Taiwan



CMSE 2017 in Beijing



CMSE 2018 in Xi'an



CMSE 2019 in Sanya







CMSE 2020& CMSE 2021& CMSE 2022

Online via MS **Teams**